

DECLARATION FOR PATENT APPLICATION
English Language Declaration

As a below-named inventor, I hereby declare that:

My residence, mailing address, and citizenship are as stated below next to my name.

I believe that I am the original, first, and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter that is claimed and for which a patent is sought on the invention entitled:

COMPOSITE POLYMER DIELECTRIC FILM

the specification of which was filed on March 31, 2004 as U.S. Patent Application Serial No. 10/816,205.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose information that is material to patentability as defined in 37 C.F.R. § 1.56, including, for continuation-in-part applications, material information that became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or (f) or 365(b) of any foreign application(s) for patent, inventor's or plant breeder's rights certificate(s), or 365(a) of any PCT international application that designated at least one country other than the United States of America, listed below, and also have identified below any foreign application for patent, inventor's or plant breeder's rights certificate(s), or any PCT international application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application Number(s)	Country	Foreign Filing Date (MM/DD/YYYY)	Priority Claimed?	Certified Copy Attached?

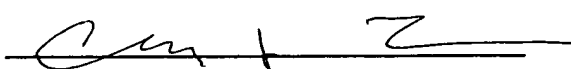
DIRECT COMMUNICATIONS TO:

M. Matthews Hall
 Kolisch Hartwell, P.C.
 200 Pacific Building
 520 S.W. Yamhill Street
 Portland, Oregon 97204

Telephone: (503) 224-6655
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 Email: hall@khpatent.com

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full name of sole or first joint inventor: CHUNG J. LEE

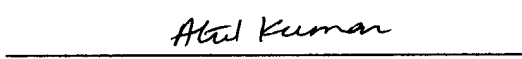
Inventor's signature:  Date: 3-30-2004

Residence: 43520 Homestead Court, Fremont, California 94538

Citizenship: United States of America

Post Office Address: 43520 Homestead Court, Fremont, California 94538

Full name of second joint inventor: ATUL KUMAR

Inventor's signature:  Date: 3/30/04

Residence: 1512 Vista Club Circle #202, Santa Clara, California 95054

Citizenship: India

Post Office Address: 1512 Vista Club Circle #202, Santa Clara, California 95054

ASSIGNMENT

COPY

WHEREAS, we, Chung J. Lee of Fremont, California, and Atul Kumar of Santa Clara, California, have invented certain improvements in COMPOSITE POLYMER DIELECTRIC FILM, for which we filed U.S. Patent Application Serial No. 10/816,205 on March 31, 2004; and

WHEREAS, Dielectric Systems, Inc., a California corporation, having its principal place of business in Fremont, California, is desirous of acquiring an interest therein;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which hereby are acknowledged, we, Chung J. Lee and Atul Kumar, have sold, assigned, and transferred, and do hereby sell, assign, and transfer, to Dielectric Systems, Inc., its successors and assigns, the full and exclusive right to the invention in the United States and its territorial possessions and in all foreign countries, and the entire right, title, and interest in and to any and all Letters Patent that may be granted therefor in the United States and its territorial possessions and in any and all foreign countries, and in and to any and all divisions, continuations, reissues, substitutions, and extensions thereof.


We hereby authorize and request the Patent Office officials in the United States and any and all foreign countries to issue any and all of said Letters Patent, when granted, to Dielectric Systems, Inc., as the assignee of our entire right, title, and interest in and to the same, for the sole use of Dielectric Systems, Inc., and its successors and assigns.

Further, we hereby covenant and agree to and with Dielectric Systems, Inc., and its successors and assigns, at the time of execution and delivery of these presents, that we are the sole and lawful owner of the entire right, title, and interest in and to the invention

and the above-identified patent application, and that the same are unencumbered, and that we have good and full right and lawful authority to sell and convey the same in the manner herein set forth.

Further, we agree that we will communicate to Dielectric Systems, Inc., or its representatives, any facts known to us respecting the invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue, substitution, and extension applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to Dielectric Systems, Inc., make all rightful oaths, and generally do everything possible to aid Dielectric Systems, Inc., and its successors and assigns, to obtain and enforce proper protection for the invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, I have hereunto set my hand this 28th
day of April, 2004.


CHUNG J. LEE

Witness:

Signature: _____

Name: _____


Address: _____

City & State: _____



SUBSCRIBED AND SWORN TO BEFORE ME

THIS 28th DAY OF April, 18 2004.

By Chung J. Lee


Thaier A. Shehadeh
Notary Public in and for the State of
California, County of Alameda

IN TESTIMONY WHEREOF, I have hereunto set my hand this 28

day of APRIL, 2004.

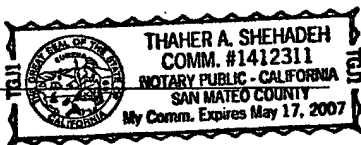
Atul Kumar

ATUL KUMAR

Witness:

Signature: _____

Name: _____



Address: _____

City & State: _____

SUBSCRIBED AND SWORN TO BEFORE ME

THIS 28th DAY OF April, 192004

By Atul Kumar
[Signature]

Thaher A. Shehadeh
Notary Public in and for the State of
California, County of Alameda



**POWER OF ATTORNEY,
STATEMENT UNDER 37 C.F.R. § 3.73(b), and
ASSERTION OF RIGHT UNDER 37 C.F.R. § 3.71 AND MPEP § 106**

Applicants: Chung J. Lee and Atul Kumar
 Serial No.: 10/816,205
 Filed: March 31, 2004
 Title: COMPOSITE POLYMER DIELECTRIC FILM

Dielectric Systems, Inc., a California corporation, hereby appoints the practitioners at Kolisch Hartwell, P.C., USPTO Customer No. 23581, as its attorneys and agents to prosecute the above-identified patent application and to transact all business in the United States Patent and Trademark Office connected therewith. These practitioners currently include:

J. Pierre Kolisch, Reg. No. 15,802; John M. McCormack, Reg. No. 26,948; Peter E. Heuser, Reg. No. 27,902; David P. Cooper, Reg. No. 33,372; Pierre C. Van Rysselberghe, Reg. No. 33,557; Walter W. Karnstein, Reg. No. 35,565; Charles H. DeVoe, Reg. No. 37,305; David S. D'Ascenzo, Reg. No. 39,952; Owen W. Dukelow, Reg. No. 41,002; James R. Abney, Reg. No. 42,253; Mark D. Alleman, Reg. No. 42,257; M. Matthews Hall, Reg. No. 43,653; Christopher S. Tuttle, Reg. No. 41,357; B. Anna McCoy, Reg. No. 46,077; Ellen M. Gonzales, Reg. No. 44,128; Jason C. Creasman, Reg. No. 51,587; Edward B. Anderson, Reg. No. 30,154; Peter D. Sabido, Reg. No. 50,353; John D. Russell, Reg. No. 47,048; Douglas W. McArthur, Reg. No. 50,795; Stanley M. Hollenberg, Reg. No. 47,658; and Anton E. Skaugset, Reg. No. 38,617.

Dielectric Systems, Inc. states, under 37 C.F.R. § 3.73(b), that it is the assignee of the entire right, title, and interest in the above-identified patent application by virtue of an assignment from each of the inventor(s) named in the above-identified patent application. Copies of assignments or other documents in the chain of title are attached.

Dielectric Systems, Inc. hereby asserts its right, under 37 C.F.R. § 3.71 and MPEP § 106, to conduct the prosecution of the above-identified patent application to the exclusion of the named inventor(s) and any previous assignee(s).

DIRECT COMMUNICATIONS TO:

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 520 S.W. Yamhill Street
 Portland, Oregon 97204

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 Facsimile: (503) 295-6679
 E-Mail: hall@khpatent.com

The undersigned (whose title is supplied below) is authorized to act on behalf of the above-identified assignee.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements are made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

DIELECTRIC SYSTEMS, INC.

Date: 3-30-2004

Chung J. Lee

Name: CHUNG J. Lee

Title: President